

2.5 x 0.7 mm Right Angle SMD Chip LED Lamp

### **Features**

- 2.5 x 0.7 x 1.0 mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- Standard Package: 3,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant

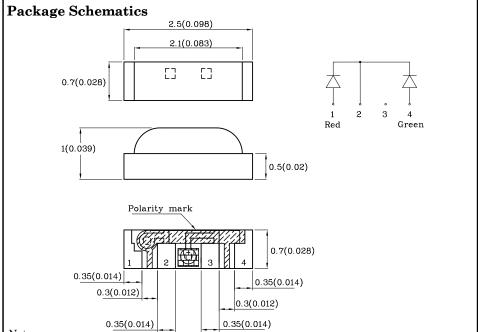






### ATTENTION OBSERVE PRECAUTIONS

FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.15(0.006")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

(T<sub>A</sub>=25°C)

 $(I_F=20mA)$ 

 $(I_F=20mA)$ 

 $(I_F=20mA)$ 

**Operating Characteristics** 

Forward Voltage (Typ.) (I<sub>F</sub>=20mA)

Forward Voltage (Max.) (I<sub>F</sub>=20mA)

Reverse Current (Max.) (V<sub>R</sub>=5V)

Emission CIE127-2007\* (Typ.)

Wavelength of Dominant Emission CIE127-2007\* (Typ.)

Spectral Line Full Width At Half-Maximum (Typ.)

Wavelength of Peak

4. The solder stencil thickness for right angle SMD LEDs should be at least 5mil in order to prevent poor solder wetting.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Red (AlGaI nP) Green (InGaN)		Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	5	V
Forward Current	$I_{\mathrm{F}}$	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$ m I_{FP}$	150	150	mA
Power Dissipation	$P_{D}$	84	102.5	mW
Electrostatic Discharge Threshold (HBM)		3000	450	V
Operating Temperature	$T_{A}$	-40 ~	°C	
Storage Temperature	Tstg	-40 %		

A Relative Humidity between 40% and 60% is recommended in
ESD-protected work areas to reduce static build up during assembly
process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous CIE127 (I <sub>F</sub> =2) m	7-2007*	Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZM2CRKXDGK161WCC —	Red	AlGaInP	– Water Clear	500 200*	795 397*	640*	130°
	Green	InGaN	- water Clear	400	547 547*	515*	

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Oct 07,2024

	50.		- 130°	
400 400*	547 547*	515*	- 150	

Red

(AlGaI

nP)

2.2

2.8

10

640\*

625\*

20

Wavelength

 $V_{\rm F}$ 

 $V_{\rm F}$ 

λΡ

 $\lambda D$ 

 $\triangle \lambda$ 

Luminous Intensity

Green

(InGaN)

3.3

4.1

50

515\*

525\*

35

Unit

V

V

μΑ

nm

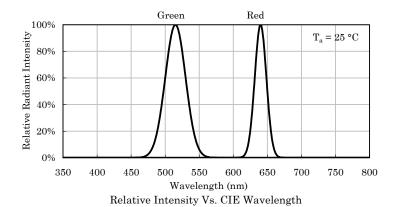
nm

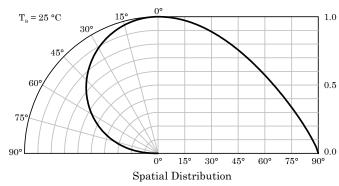
nm

XDSB9589 V2-X Layout: Maggie L.

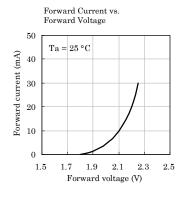


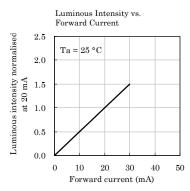


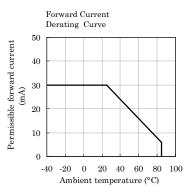


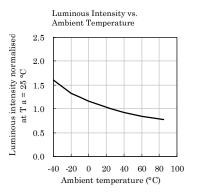


### \* Red

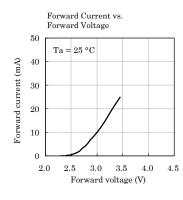


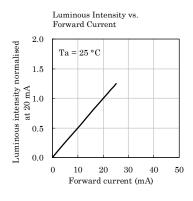


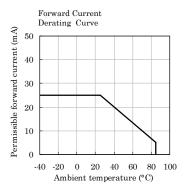


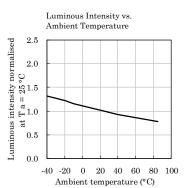


### **❖** Green









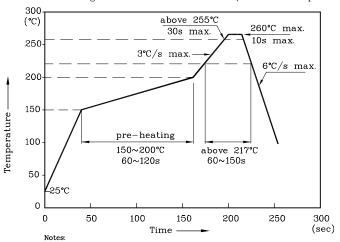
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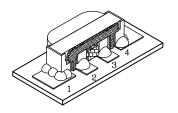
# **❖** LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

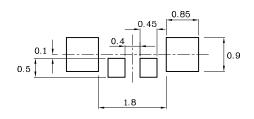


- All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
- 2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

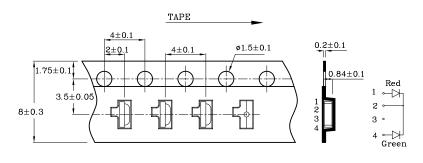
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



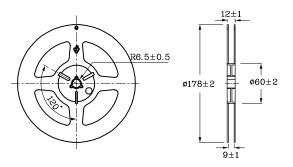
## **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Tape Specification (Units:mm)



### ❖ Reel Dimension (Units : mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

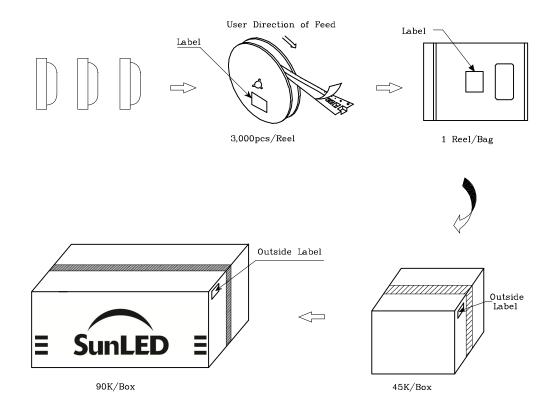
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

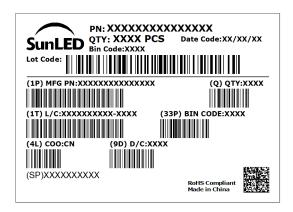
Note: Accuracy may depend on the sorting parameters.





### PACKING & LABEL SPECIFICATIONS





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